

# ZXTP03200BG 200V PNP Low V<sub>CE</sub>(sat) transistor in SOT223

## Summary

 $BV_{CEO} > -200V$   $BV_{ECO} > -2V$   $I_{C(cont)} = 2A$   $V_{CE(sat)} < -160mV @ -1A$   $R_{CE(sat)} = 135m\Omega$  $P_D = 3W$ 



### Description

Packaged in the SOT223 outline this new 5<sup>th</sup> generation low saturation 200V PNP transistor offers extremely low on state losses making it ideal for use in DC-DC circuits and various driving and power management functions

### Features

- 2 Amps continuous current
- Up to 5 Amps peak current
- Very low saturation voltage
- Enhanced switching performance

### Applications

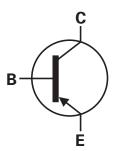
DC-DC conversion

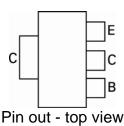
### **Ordering Information**

Device	Reel size	Tape width	Quantity	
	(inches)	(mm)	per reel	
ZXTP03200BGTA	7	12	1000	

### Device Marking

ZXTP03200BG





## **Absolute Maximum Ratings**

Parameter	Symbol	Limit	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-220	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-200	V
Emitter-Base Voltage	V <sub>EBO</sub>	-7	V
Continuous Collector Current <sup>(a)</sup>	Ι <sub>C</sub>	-2	А
Base Current	Ι <sub>Β</sub>	-1	А
Peak Pulse Current	ICM	-5	А
Power Dissipation at T <sub>A</sub> =25°C <sup>(a)</sup> Linear Derating Factor	PD	1.25 10	W mW/°C
Power Dissipation at T <sub>A</sub> =25°C <sup>(b)</sup> Linear Derating Factor	PD	1.65 13.2	W mW/°C
Power Dissipation at T <sub>A</sub> =25°C <sup>(C)</sup> Linear Derating Factor	PD	3 24	W mW/°C
Power Dissipation at T <sub>A</sub> =25°C <sup>(d)</sup> Linear Derating Factor	PD	5.8 46.5	W mW/°C
Power Dissipation at T <sub>c</sub> =25°C <sup>(e)</sup> Linear Derating Factor	PD	11.9 95.2	W mW/°C
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	-55 to 150	°C

### **Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction to Ambient <sup>(a)</sup>	$R_{ heta JA}$	100	°C/W
Junction to Ambient <sup>(b)</sup>	$R_{ ext{ heta}JA}$	76	°C/W
Junction to Ambient <sup>(C)</sup>	$R_{\theta JA}$	41.6	°C/W
Junction to Ambient <sup>(d)</sup>	$R_{ ext{ heta}JA}$	21.5	°C/W
Junction to Lead <sup>(e)</sup>	R <sub>0JL</sub>	10.5	°C/W

NOTES:

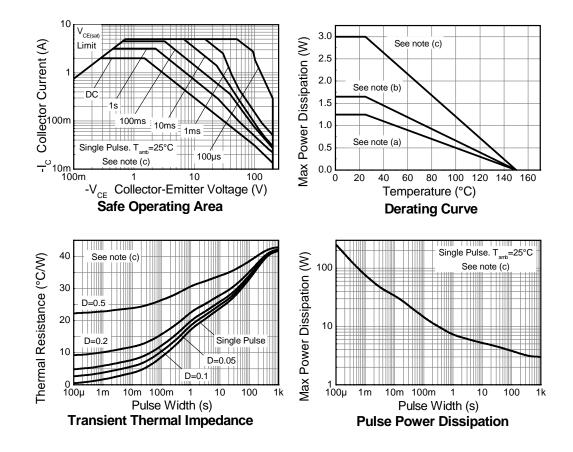
(a) For a device surface mounted on 15mm x 15mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

(b) Mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

(c) Mounted on 20mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 2oz copper, in still air conditions.
(d) As (c) above measured at t<5 seconds.</li>

(e) Junction to Lead from Collector Tab.Typical

### **Thermal Characteristics**



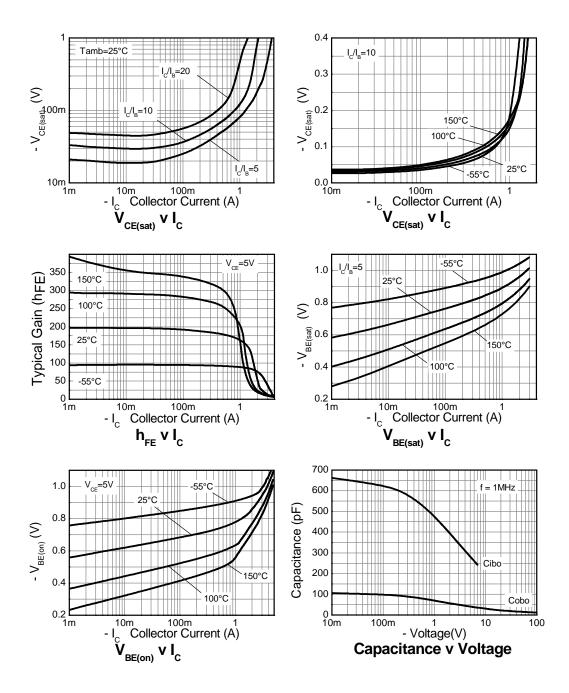
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-220	-245		V	I <sub>C</sub> = -100μA
Collector-Emitter Breakdown Voltage	BV <sub>CER</sub>	-220	-245		V	I <sub>C</sub> = -1μΑ, R <sub>BE</sub> ≤ 1kΩ
Collector-Emitter Breakdown voltage	BV <sub>CEO</sub>	-200	-225		V	I <sub>c</sub> = -10mA <sup>(*)</sup>
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-7	-8.4		V	I <sub>E</sub> = -100μA
Collector-Base Cut-off	I <sub>CBO</sub>		<1	-50	nA	V <sub>CB</sub> = -200V
Current				-0.5	μA	$V_{CB}$ = -200V, $T_{amb}$ =100°C
Emitter Cut-off Current	I <sub>EBO</sub>		<1	-10	nA	V <sub>EB</sub> = -6V
Collector-Emitter Saturation	V <sub>CE(sat)</sub>		-37	-50	mV	$I_{C} = -0.1A, I_{B} = -10mA^{(*)}$
Voltage			-130	-155	mV	$I_{C} = -0.5A, I_{B} = -25mA_{(*)}^{(*)}$
			-135	-160	mV	$I_{C} = -1A, I_{B} = -100 \text{mA}^{(*)}$
			-180	-275	mV	$I_{C} = -2A, I_{B} = -400 \text{mA}^{(*)}$
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>		-955	-1100	mV	$I_{C}$ = -2A, $I_{B}$ = -400mA <sup>(*)</sup>
Base-Emitter Turn-On Voltage	V <sub>BE(on)</sub>		-860	-1000	mV	$I_{C} = -2A, V_{CE} = -5V^{(*)}$
Static Forward Current	h <sub>FE</sub>	100	195			$I_{C} = -10 \text{mA}, V_{CE} = -5 V^{(*)}$
Transfer Ratio		100	170	300		$I_{C} = -1A, V_{CE} = -5V^{(*)}$
		20	50			$I_{C} = -2A, V_{CE} = -5V^{(*)}$
			5			I <sub>C</sub> = -5A, V <sub>CE</sub> = -5V <sup>(*)</sup>
Transition Frequency	f <sub>T</sub>		105		MHz	I <sub>C</sub> = -100mA, V <sub>CE</sub> = -10V f = 50MHz
Output Capacitance	C <sub>obo</sub>		31		pF	$V_{CB} = -10V, f = 1MHz^{(*)}$
Delay Time	t <sub>d</sub>		21		ns	
Rise Time	t <sub>r</sub>		18		ns	I <sub>C</sub> = -1A, V <sub>CC</sub> = -50V,
Storage Time	t <sub>s</sub>		680		ns	$I_{B1} = -I_{B2} = -100 \text{mA}$
Fall Time	t <sub>f</sub>		75		ns	

## Electrical Characteristics (at T<sub>amb</sub> = 25°C unless otherwise stated)

### NOTES:

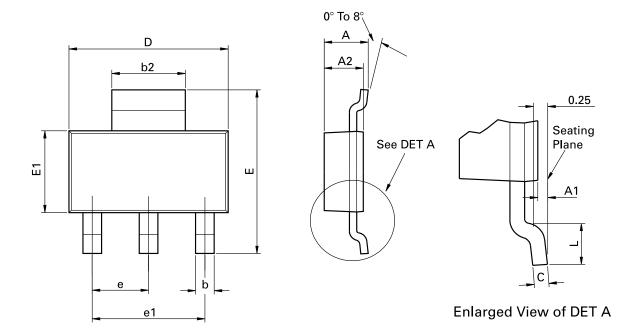
(\*) Measured under pulsed conditions. Pulse width  $\leq 300 \mu s;$  duty cycle  $\leq 2\%.$ 

## **Typical Characteristics**



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## Package Information – SOT223



Conforms to JEDEC TO-261 AA Issue B

DIM	Millim	neters	Inc	hes	DIM	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
А	-	1.80	-	0.071	е	2.30 BSC		0.0905 BSC	
A1	0.02	0.10	0.0008	0.004	e1	4.60 BSC		0.181 BSC	
b	0.66	0.84	0.026	0.033	E	6.70	7.30	0.264	0.287
b2	2.90	3.10	0.114	0.122	E1	3.30	3.70	0.130	0.146
С	0.23	0.33	0.009	0.013	L	0.90	-	0.355	-
D	6.30	6.70	0.248	0.264	-	-	-	-	-

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